

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HSIN-CHE CHIANG	06/12/2017
JU-YUAN TZENG	06/12/2017
CHUN-SHENG LIANG	06/12/2017
SHU-HUI WANG	06/12/2017
CHIH-YANG YEH	06/12/2017
JENG-YA DAVID YEH	06/13/2017
RECEIVING PARTY DATA	
Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
Street Address:	NO.8, LI-HSIN RD.6
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16678642
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	R. BURNS ISRAELSEN
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ATTORNEY DOCKET NUMBER:	T1516.10630US03
NAME OF SUBMITTER:	R. BURNS ISRAELSEN
SIGNATURE:	/R. Burns Israelson, Reg. No. 42685/
DATE SIGNED:	11/11/2019

Total Attachments: 2

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ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title) _____
SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME

The PATENT RIGHTS referred to in this agreement are:

- (check one) ☒ a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.
- ☐ U.S. patent application Serial No. _____, filed _____
- ☐ a U.S. patent application based on PCT International Application No. _____ filed on (date) _____ (U.S. patent application Serial No. _____, if known).
- ☐ U.S. patent No. _____, issued _____.

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

- (check one) ☒ U.S. patent rights only.
- ☐ Worldwide patent rights. In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. or foreign patent application for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures appear on page 2 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
(Address) NO.8, LI-HSIN RD.6, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU, TAIWAN 300, R.O.C.

The ASSIGNEE is:

- (check one) ☐ An individual.
- ☐ A Partnership.
- ☒ A Corporation of TAIWAN, R.O.C. (specify state or country)
- ☐ (other) _____

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;
the entire right, title and interest in and to the PATENT RIGHTS;
the right to sue and recover for any past infringement; and
the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO
 ASSIGNEE: TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
 INVENTION TITLE: SEMICONDUCTOR DEVICE AND METHOD FOR
MANUFACTURING THE SAME

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

<u>Hsin-Che CHIANG</u>	<u>Hsin-Che CHIANG</u>	<u>2017/6/12</u>
Name of sole or first inventor	Signature	Date
<u>Ju-Yuan TZENG</u>	<u>Ju-Yuan Tzeng</u>	<u>2017/6/12</u>
Name of second inventor, if any	Signature	Date
<u>Chun-Sheng LIANG</u>	<u>Chun-Sheng Liang</u>	<u>2017/06/12</u>
Name of third inventor, if any	Signature	Date
<u>Shu-Hui WANG</u>	<u>Shu-Hui Wang</u>	<u>2017/6/12</u>
Name of fourth inventor, if any	Signature	Date
<u>Chih-Yang YEH</u>	<u>Chih-Yang Yeh</u>	<u>2017/6/12</u>
Name of fifth inventor, if any	Signature	Date
<u>Jeng-Ya David YEH</u>	<u>Jeng-Ya David Yeh</u>	<u>6/13/2017</u>
Name of sixth inventor, if any	Signature	Date